ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND		0	.3V to +6V
IN, OUT, COM, OS, CLI	K, SHDN	0.3V to (Vr	0.3V
OUT Short-Circuit Durat			
Continuous Power Dissi	pation $(T_A = +$	+70°C)	
8-Pin µMAX (derate 4	.1mW/°C abo	ve +70°C)	330mW

Operating Temperature Ranges	
MAX74C_A	0°C to +70°C
MAX74E_A	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—MAX7418–MAX7421

 $\underline{\text{(VDD}} = +5\text{V}$, filter output measured at OUT, 10k Ω II 50pF load to GND at OUT, OS = COM, 0.1 μ F capacitor from COM to GND, $\overline{\text{SHDN}} = \text{V}_{DD}$, $f_{CLK} = 2.2\text{MHz}$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
FILTER CHARACTERISTICS							'	
Corner Frequency	f _C	V _{IN} = 4Vp-p (Note 1)		0.001 to 30		0	kHz	
Clock-to-Corner Ratio	fcLK / fc			100:1				
Clock-to-Corner Tempco					10		ppm/°C	
Output Voltage Range				0.25	V	D - 0.25	V	
Output Offset Voltage	Voffset	V _{IN} = V _{COM} = V _{DD} / 2			±4	±25	mV	
DC Insertion Gain with		V _{COM} = V _{DD} / 2	MAX7418/MAX7421	0	0.2	0.4	dB	
Output Offset Removed		(Note 2)	MAX7419/MAX7420	-0.2	0	+0.2	ub	
		f _{IN} = 2KHz,	MAX7418		-76			
Total Harmonic Distortion	THD+N	$V_{IN} = 4V_{p-p}$	MAX7419		-78		dB	
plus Noise	IIID+N	measurement	MAX7420		-67		uB	
		bandwidth = 80kHz	MAX7421		-78		1	
Offset Voltage Gain	Aos	OS to OUT			1		V/V	
COM Voltage Range	Vcom	Input, COM externally	driven	2.0	2.5	3.0	V	
Cow voilage Hange	V COM	Output, COM unconne	Output, COM unconnected		2.5	2.7	ľ	
Input Voltage Range at OS	Vos	Input, OS externally dr	iven	,	VCOM ±0.	1	V	
Input Resistance at COM	RCOM			100	140		kΩ	
Clock Feedthrough					5		mVp-p	
Resistive Output Load Drive	RL			10	1		kΩ	
Maximum Capacitive Output Load Drive	CL			50	500		рF	
Input Leakage Current at COM		SHDN = GND, V _{COM} =	0 to V _{DD}		±0.1	±10	μΑ	
Input Leakage Current at OS		$V_{OS} = 0$ to V_{DD}			±0.1	±10	μΑ	
CLOCK								
Internal Oscillator Frequency	fosc	C _{OSC} = 1000pF (Note	MAX7418/MAX7421	68	87	106	kHz	
Internal Oscillator Frequency	1080	3)	MAX7419/MAX7420	86	110	135	KITZ	
Clock Output Current	lour	V _{CLK} = 0 or 5V	MAX7418/MAX7421		±40	±60	μA	
(Internal Oscillator Mode)	ICLK	ACFK = 0.01.2A	MAX7419/MAX7420		±50	±75	μA	
Clock Input High	VIH			4.5			V	
Clock Input Low	V _{IL}					0.5	V	

ELECTRICAL CHARACTERISTICS—MAX7418–MAX7421 (continued)

 $(V_{DD} = +5V, \text{ filter output measured at OUT, } 10k\Omega \text{ II } 50pF \text{ load to GND at OUT, } OS = COM, 0.1\mu F \text{ capacitor from COM to GND, } SHDN = V_{DD}, f_{CLK} = 2.2MHz, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}\text{C.}$)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
POWER REQUIREMENTS							
Supply Voltage	V _{DD}			4.5		5.5	V
Supply Current	loo	Operating mode, no	MAX7418/MAX7421		2.9	3.6	mΛ
Supply Current	IDD	load	MAX7419/MAX7420		3.4	4.1	— mA
Shutdown Current	ISHDN	SHDN = GND	•		0.2	1	μΑ
Power-Supply Rejection Ratio	PSRR	IN = COM (Note 4)			70		dB
SHUTDOWN							
SHDN Input High	V _{SDH}			4.5			V
SHDN Input Low	V _{SDL}					0.5	V
SHDN Input Leakage Current		$V \overline{SHDN} = 0 \text{ to } V_{DD}$			±0.2	±10	μΑ

ELECTRICAL CHARACTERISTICS—MAX7422–MAX7425

 $\underline{(V_{DD}=+3V, \text{ filter output measured at OUT pin, } 10k\Omega \text{ II 50pF load to GND at OUT, OS = COM, } 0.1\mu\text{F capacitor from COM to GND, } SHDN = V_{DD}, f_{CLK} = 2.2MHz, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C.}$)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
FILTER CHARACTERISTICS							l .
Carpar Fraguency Banga	fo	V _{IN} = 2.5Vp-p	MAX7422/MAX7425	100:1 to 45		A.E.	kHz
Corner-Frequency Range	fC	(Note 1)	MAX7423/MAX7424		100.1 10	40	KITZ
Clock-to-Corner Ratio	fCLK/fC				100:1		
Clock-to-Corner Tempco					10		ppm/°C
Output Voltage Range				0.25		V _{DD} - 0.25	V
Output Offset Voltage	Voffset	VIN = VCOM = VDD / 2	2		±4	±25	mV
DC Insertion Gain with Output		V _{COM} = V _{DD} / 2	MAX7422/MAX7425	0	0.2	0.4	dB
Offset Removed		(Note 2)	MAX7423/MAX7424	-0.2	0	+0.2	иБ
		fin = 2kHz,	MAX7422		-80		
Total Harmonic Distortion plus Noise	THD+N	$V_{IN} = 2.5Vp-p,$	MAX7423		-81		dB
	IUD+N	measurement	MAX7424		-70		
		bandwidth = 80kHz	MAX7425		-80		
Offset Voltage Gain	Aos	OS to OUT			1		V/V
COM Voltage Pange	V	Input, COM externally	y driven	1.4	1.5	1.6	V
COM Voltage Range	V _{COM}	Output, COM internal	lly driven	1.4	1.5	1.6	V
Input Voltage Range at OS	Vos	Measured with respe	ct to COM		V _{COM} ±0).1	V
Input Resistance at COM	Rcom			100	140		kΩ
Clock Feedthrough					3		mVp-p
Resistive Output Load Drive	RL			10	1		kΩ
Maximum Capacitive Load at OUT	CL			50	500		pF
Input Leakage Current at COM		SHDN = GND, V _{COM}	= 0 to V _{DD}		±0.1	±10	μΑ
Input Leakage Current at OS		$V_{OS} = 0$ to V_{DD}			±0.1	±10	μΑ

ELECTRICAL CHARACTERISTICS—MAX7422–MAX7425 (continued)

 $\frac{(V_{DD} = +3V, \text{ filter output measured at OUT pin, } 10k\Omega \text{ II 50pF load to GND at OUT, OS} = \text{COM, } 0.1\mu\text{F capacitor from COM to GND, } \\ \overline{\text{SHDN}} = V_{DD}, f_{CLK} = 2.2\text{MHz}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}\text{C.})$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
CLOCK							
Internal Oscillator Fraguency	food	C _{OSC} = 1000pF	MAX7422/MAX7425	68	87	106	kHz
Internal Oscillator Frequency	fosc	(Note 3)	MAX7423/MAX7424	86	110	135	KUZ
Clock Output Current (Internal	lour		MAX7422/MAX7425	68	87	106	kHz
Oscillator Mode)	ICLK		MAX7423/MAX7424	86	110	135	KUZ
Clock Input High	VIH			2.5			
Clock Input Low	VIL					0.5	
POWER REQUIREMENTS	•						
Supply Voltage	V _{DD}			2.7		3.6	V
Supply Current	loo	Operating mode,	MAX7422/MAX7425		2.6	3.4	mA
Supply Current	IDD	no load	MAX7423/MAX7424		3.0	3.8	
Shutdown Current	ISHDN	SHDN = GND			0.2	1	μΑ
Power-Supply Rejection Ratio	PSRR	Measured at DC			70		dB
SHUTDOWN							
SHDN Input High	V _{SDH}			2.5			V
SHDN Input Low	V _{SDL}					0.5	V
SHDN Input Leakage Current		$V_{\overline{SHDN}} = 0$ to V_{DD}			±0.2	±10	μΑ

FILTER CHARACTERISTICS

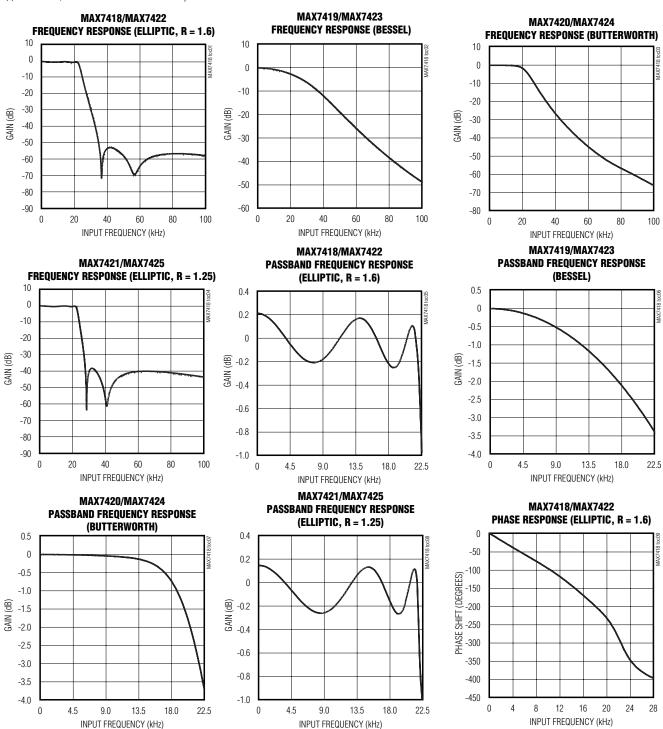
 $(V_{DD} = +5V \text{ for MAX7418-MAX7420}, V_{DD} = +3V \text{ for MAX7422-MAX7425 filter output measured at OUT, } 10k\Omega \text{ II } 50pF \text{ load to GND at OUT, } \overline{SHDN} = V_{DD}, f_{CLK} = 2.2MHz, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
ELLIPTIC, R = 1.2—MAX7421	/MAX7425	,				
	$f_{IN} = 0.38f_{C}$	-0.4	-0.2	0.4		
	$f_{IN} = 0.68f_{C}$	-0.4	-0.2	0.4		
	$f_{IN} = 0.87f_{C}$	-0.4	-0.2	0.4		
Insertion Gain with DC Gain	$f_{IN} = 0.97f_{C}$	-0.4	-0.2	0.4	dB	
Error Removed (Note 4)	$f_{IN} = f_C$	-0.7	-0.2	0.2	иь	
	$f_{IN} = 1.25f_{C}$		-36	-33		
	$f_{IN} = 1.43f_{C}$		-37.2	-35		
	$f_{IN} = 3.25f_{C}$		-37.2	-35		
BESSEL FILTERS—MAX7419	/MAX7423	•				
	$f_{IN} = 0.5f_{C}$	-1	-0.74		- dB	
Insertion Gain Relative to	$f_{IN} = f_C$	-3.6	-3.0	-2.4		
DC Gain	$f_{IN} = 4f_{C}$		-41.0	-35		
	$f_{IN} = 7f_{C}$		-67	-60		
BESSEL FILTERS—MAX7419	/MAX7423	,				
	$f_{IN} = 0.5f_{C}$	-1.0	-0.74			
Insertion Gain Relative to	$f_{IN} = 4f_{C}$	-3.6	-3.0	-2.4	dB	
DC Gain	$f_{IN} = 7f_{C}$		-41.0	-35	иБ	
	$f_{IN} = 7f_{C}$		-67	-60		
BUTTERWORTH FILTERS—N	MAX7420/MAX7424					
	$f_{IN} = 0.5f_{C}$	-0.3	0			
Insertion Gain Relative to	$f_{IN} = f_C$	-3.6	-3.0	-2.4	dB	
DC Gain	$f_{IN} = 3f_{C}$		-47.5	-43	UD	
	$f_{IN} = 5f_{C}$		-70	-65	-	

- **Note 1:** The maximum f_C is defined as the clock frequency $f_{CLK} = 100 \times f_C$ at which the peak S / (THD+N) drops to 68dB with a sinusoidal input at 0.2 f_C . Maximum f_C increases as V_{IN} signal amplitude decreases.
- **Note 2:** DC insertion gain is defined as $\Delta V_{OUT} / \Delta V_{IN}$.
- Note 3: MAX7418/MAX7421/MAX7422/MAX7425: f_{OSC} (kHz) $\cong 87 \times 10^3$ / C_{OSC} (pF). MAX7419/MAX7420/MAX7423/MAX7424: f_{OSC} (kHz) $\cong 110 \times 10^3$ / C_{OSC} (pF).
- **Note 4:** PSRR is the change in output voltage from a V_{DD} of 4.5V and a V_{DD} of 5.5V.

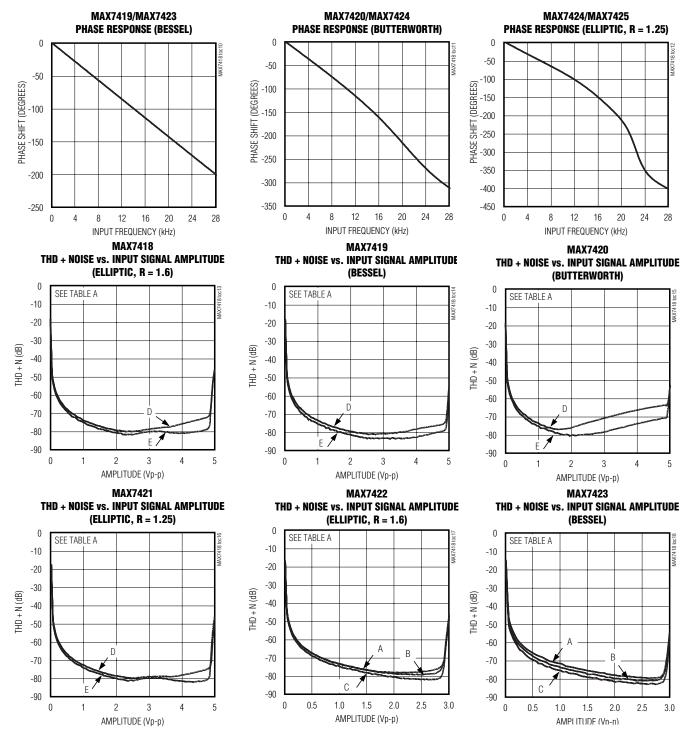
Typical Operating Characteristics

 $(V_{DD} = +5V \text{ for MAX7418-MAX7421}, V_{DD} = +3V \text{ for MAX7422-MAX7425}; f_{CLK} = 2.2MHz; \overline{SHDN} = V_{DD}; V_{COM} = V_{OS} = V_{DD} / 2; T_A = +25^{\circ}C; unless otherwise noted.)$



Typical Operating Characteristics (continued)

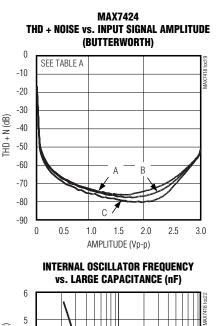
 $(V_{DD} = +5V \text{ for MAX7418-MAX7421}, V_{DD} = +3V \text{ for MAX7422-MAX7425}; f_{CLK} = 2.2MHz; \overline{SHDN} = V_{DD}; V_{COM} = V_{OS} = V_{DD} / 2; T_A = +25^{\circ}C; unless otherwise noted.)$

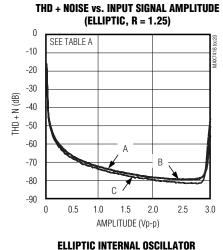


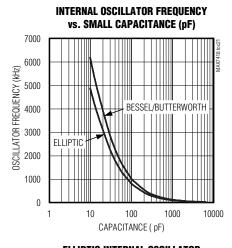
Typical Operating Characteristics (continued)

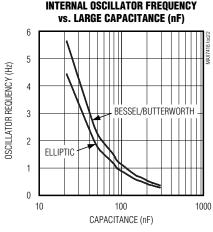
 $(V_{DD} = +5V \text{ for MAX7418-MAX7421}, V_{DD} = +3V \text{ for MAX7422-MAX7425}; f_{CLK} = 2.2MHz; \overline{SHDN} = V_{DD}; V_{COM} = V_{OS} = V_{DD} / 2; T_A = +25^{\circ}C; unless otherwise noted.)$

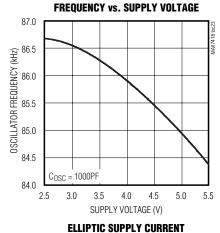
MAX7425

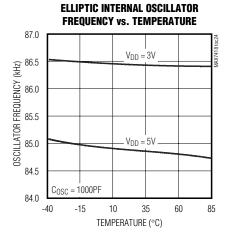


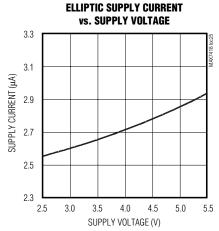












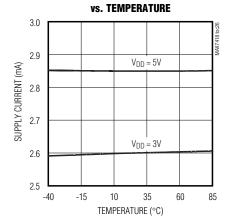
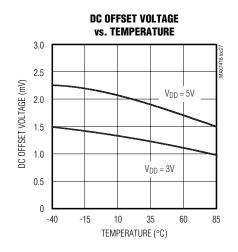


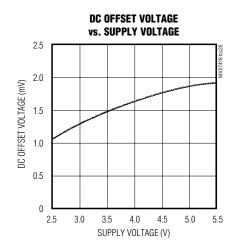
Table A.

LABEL	f _{IN} (kHz)	f _C (kHz)	f _{CLK} (kHz)	BW (kHz)
А	2	30	3000	80
В	2	22	2200	80
С	1	10	1000	22
D	2	22	2200	80
Е	1	10	1000	22

Typical Operating Characteristics (continued)

 $(V_{DD} = +5V \text{ for MAX7418-MAX7421}, V_{DD} = +3V \text{ for MAX7422-MAX7425}; f_{CLK} = 2.2MHz; \overline{SHDN} = V_{DD}; V_{COM} = V_{OS} = V_{DD} / 2; T_A = +25^{\circ}C; unless otherwise noted.)$





Pin Description

PIN	NAME	FUNCTION
1	COM	Common Input Pin. Biased internally at midsupply. Bypass COM externally to GND with a 0.1µF capacitor. To override internal biasing, drive COM with an external supply.
2	IN	Filter Input
3	GND	Ground
4	V _{DD}	Positive Supply Input: +5V for MAX7418–MAX7421, +3V for MAX7422–MAX7425. Bypass V _{DD} to GND with a 0.1µF capacitor.
5	OUT	Filter Output
6	OS	Offset Adjust Input. To adjust output offset, connect OS to an external supply through a resistive voltage-divider (Figure 4). Connect OS to COM if no offset adjustment is needed. The Offset and Common-Mode Input Adjustment section.
7	SHDN	Shutdown Input. Drive low to enable shutdown mode; drive high or connect to V _{DD} for normal operation.
8	CLK	Clock Input. Connect an external capacitor (C_{OSC}) from CLK to ground. To override the internal oscillator, connect CLK to an external clock: $f_C = f_{CLK}/100$.

Detailed Description

The MAX7418/MAX7421/MAX7422/MAX7425 elliptic lowpass filters provide sharp rolloff with good stopband rejection. The MAX7419/MAX7423 Bessel filters provide low overshoot and fast settling responses, and the MAX7420/MAX7424 Butterworth filters provide a maximally flat passband response. All parts operate with a 100:1 clock-to-corner frequency ratio.

Most switch capacitor filters (SCFs) are designed with biquadratic sections. Each section implements two pole-zero pairs, and the sections can be cascaded to

produce higher order filters. The advantage to this approach is ease of design. However, this type of design is highly sensitive to component variations if any section's Q is high. The MAX7418–MAX7425 use an alternative approach, which is to emulate a passive network using switched-capacitor integrators with summing and scaling. The passive network may be synthesized using CAD programs, or may be found in many filter books. Figure 1 shows a basic 5th-order ladder filter structure.

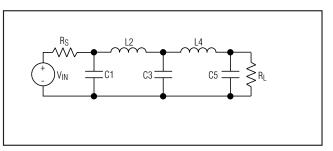


Figure 1. 5th-Order Ladder Filter Network

An SCF that emulates a passive ladder filter retains many of the same advantages. The component sensitivity of a passive ladder filter is low when compared to a cascaded biquadratic design because each component affects the entire filter shape rather than a single pole-zero pair. In other words, a mismatched component in a biquadratic design has a concentrated error on its respective poles, while the same mismatch in a ladder filter design spreads its error over all poles.

Elliptic Characteristics

Lowpass elliptic filters such as the MAX7418/MAX7421/MAX7422/MAX7425 provide the steepest possible rolloff with frequency of the four most common filter types (Butterworth, Bessel, Chebyshev, and elliptic). The high-Q value of the poles near the passband edge combined with the stopband zeros allow for the sharp attenuation characteristic of elliptic filters, making these devices ideal for anti-aliasing and post-DAC filtering in single-supply systems (see *Anti-Aliasing and Post-DAC Filtering*).

In the frequency domain, the first transmission zero causes the filter's amplitude to drop to a minimum level (Figure 2). Beyond this zero, the response rises as the frequency increases until the next transmission zero. The stopband begins at the stopband frequency, fg. At frequencies above fg, the filter's gain does not exceed the gain at fg. The corner frequency, fg, is defined as the point at which the filter output attenuation falls just below the passband ripple. The transition ratio (r) is defined as the ratio of the stopband frequency to the corner frequency:

$$r = fs / fc$$

The MAX7418/MAX7422 have a transition ratio of 1.6 and typically 53dB of stopband rejection. The MAX7421/MAX7425 have a transition ratio of 1.25 (providing a steeper rolloff) and typically 37dB of stopband rejection.

Bessel Characteristics

Lowpass Bessel filters such as the MAX7419/MAX7423

delay all frequency components equally, preserving the line up shape of step inputs (subject to the attenuation of the higher frequencies). Bessel filters settle quickly—an important characteristic in applications that use a multiplexer (mux) to select an input signal for an analog-to-digital converter (ADC). An anti-aliasing filter placed between the mux and the ADC must settle quickly after a new channel is selected.

Butterworth Characteristics

Lowpass Butterworth filters such as the MAX7420/MAX7424 provide a maximally flat passband response, making them ideal for instrumentation applications that require minimum deviation from the DC gain throughout the passband.

The difference between Bessel and Butterworth filters can be observed when a 1kHz square wave is applied to the filter input (Figure 3, trace A). With the filter cutoff frequencies set at 5kHz, trace B shows the Bessel filter response and trace C shows the Butterworth filter response.

Clock Signal

External Clock

These SCFs are designed for use with external clocks that have a 40% to 60% duty cycle. When using an external clock, drive the CLK pin with a CMOS gate powered from 0 to V_{DD} . Varying the rate of the external clock adjusts the corner frequency of the filter:

$$f_C = \frac{f_{CLK}}{100}$$

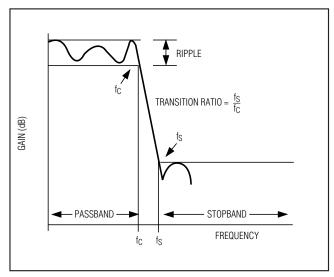


Figure 2. Elliptic Filter Response

/U/XI/N

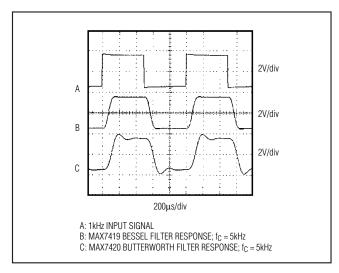


Figure 3. Bessel vs. Butterworth Filter Response

Internal Clock

When using the internal oscillator, the capacitance (Cosc) on CLK determines the oscillator frequency:

$$f_{OSC}(kHz) = \frac{k}{C_{OSC}(pF)}$$

where

k=87x10³ for the MAX7418/MAX7421/MAX7422/MAX7425

k=110X10³ for the MAX7419/MAX7420/MAX7423/ MAX7424.

Since Cosc is in the low picofarads, minimize the stray capacitance at CLK so that it does not affect the internal oscillator frequency. Varying the rate of the internal oscillator adjusts the filter's corner frequency by a 100:1 clock-to-corner frequency ratio. For example, an internal oscillator frequency of 2.2kHz produces a nominal corner frequency of 2.2MHz.

Input Impedance vs. Clock Frequencies

The MAX7418–MAX7425s' input impedance is effectively that of a switched-capacitor resistor (see the following equation), and is inversely proportional to frequency. The input impedance values determined by the equation represent the average input impedance, since the input current is not continuous. As a rule, use a driver with an output resistance less than 10% of the filter's input impedance.

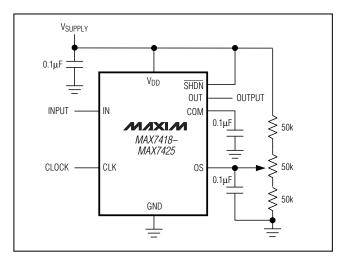


Figure 4. Offset Adjustment Circuit

Estimate the input impedance of the filter by using the following formula:

$$Z_{IN} = \frac{1}{(f_{CLK} \times C_{IN})}$$

where $f_{CLK} = clock$ frequency and $C_{IN} = 1pF$.

Low-Power Shutdown Mode

The MAX7418–MAX7425 have a shutdown mode that is activated by driving \overline{SHDN} low. In shutdown mode, the filter supply current reduces to 0.2µA, and the output of the filter becomes high impedance. For normal operation, drive \overline{SHDN} high or connect to V_{DD}.

_Applications Information

Offset (OS) and Common-Mode (COM) Input Adjustment

COM sets the common-mode input voltage and is biased at midsupply with an internal resistor-divider. If the application does not require offset adjustment, connect OS to COM. For applications in which offset adjustment is required, apply an external bias voltage through a resistor-divider network to OS, as shown in Figure 4. For applications that require DC level shifting, adjust OS with respect to COM. (**Note:** Do not leave OS unconnected.) The output voltage is represented by these equations:

$$V_{OUT} = (V_{IN} - V_{COM}) + V_{OS}$$

 $V_{COM} = \frac{V_{DD}}{2}$ (typical)

where $(V_{\text{IN}}$ - $V_{\text{COM}})$ is lowpass filtered by the SCF and OS is added at the output stage. See the *Electrical*

Characteristics table for the input voltage range of COM and OS. Changing the voltage on COM or OS significantly from midsupply reduces the dynamic range.

Power Supplies

The MAX7418–MAX7421 operate from a single +5V supply and the MAX7422–MAX7425 operate from a single +3V supply. Bypass V_{DD} to GND with a 0.1µF capacitor. If dual supplies are required, connect COM to the system ground and GND to the negative supply. Figure 5 shows an example of dual-supply operation. Single-supply and dual-supply performance are equivalent. For either single-supply or dual-supply operation, drive CLK and SHDN from GND (V- in dual supply operation) to V_{DD}. Use the MAX7418–MAX7421 for ±2.5, and use the MAX7422–MAX7425 for ±1.5V. For ±5V dual-supply applications, refer to the MAX291/MAX292/MAX295/MAX296 and MAX293/MAX294/MAX297 data sheets.

Input Signal Amplitude Range

The optimal input signal range is determined by observing the voltage level at which the signal-to-noise plus distortion (SINAD) ratio is maximized for a given corner frequency. The *Typical Operating Characteristics* show the THD + Noise response as the input signal's peak-to-peak amplitude is varied.

Anti-Aliasing and Post-DAC Filtering

When using the MAX7418–MAX7425 for anti-aliasing or post-DAC filtering, synchronize the DAC (or ADC) and the filter clocks. If the clocks are not synchronized, beat frequencies may alias into the desired passband.

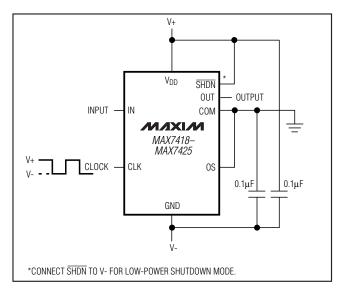


Figure 5. Dual-Supply Operation

Harmonic Distortion

Harmonic distortion arises from nonlinearities within the filter. These nonlinearities generate harmonics when a pure sine wave is applied to the filter input. Tables 1, 2, and 3 list typical harmonic distortion values with a $10k\Omega$ load at $T_A=+25^{\circ}C.$

Table 1. MAX7418/MAX7421/MAX7422/MAX7425 Typical Harmonic Distortion

FILTER	fclk	fiN	V _{IN}	TYPICA	AL HARMONI	C DISTORTIO	ON (dB)
FILTER	(MHz)	(kHz)	(Vp-p)	2nd	3rd	4th	5th
MAX7418	2.2	2	1	<-80	<-80	<-80	<-80
IVIAX7416	1.5	2	4	<-80	<-80	<-80	<-80
MAX7421	2.2	2	4	<-80	<-80	<-80	<-80
IVIAX7421	1.5	2	4	<-80	<-80	<-80	<-80
MAX7422	4.0	4	2	<-80	<-80	<-80	<-80
IVIAX1422	2.2	2		<-80	<-80	<-80	<-80
MAX7425	4.0	4	2	<-80	<-80	<-80	<-80
101/2/1423	2.2	2	2	<-80	<-80	<-80	<-80

Table 2. MAX7420/MAX7424 Typical Harmonic Distortion

FILTER	fclk	fin	VIN	TYPICA	VIN TYPICAL HARMONIC DISTORTION				
FILTER	(MHz)	(kHz)	(Vp-p)	2nd	3rd	4th	5th		
MAX7420	2.2	2	4	-77	-67	< -80	-76		
WAX7420	1.5	2	- 4	< -80	-70	< -80	< -80		
MAX7424	3.5	3	2	< -80	-70	< -80	< -80		
IVIAA / 424	2.2	2	- 2	< -80	-77	< -80	< -80		

Table 3. MAX7419/MAX7423 Typical Harmonic Distortion

FILTER fcl	fclk	fiN	K fin VIN TYPICAL HARMON				IC DISTORTION (dB)		
FILTER	(MHz)	(kHz)	(Vp-p)	2nd	3rd	4th	5th		
MAX7419	2.2	2	4	< -80	-77	< -80	< -80		
IVIAA7419	1.5	2	4	< -80	-80	< -80	< -80		
MAX7423	3.5	3	2	< -80	-75	< -80	< -80		
IVIAA7423	2.2	2		< -80	< -80	< -80	< -80		

__Ordering Information (continued) _____Selector Guide (continued)

PART	TEMP. RANGE	PIN-PACKAGE
MAX7422CUA	0°C to +70°C	8 µMAX
MAX7422EUA	-40°C to +85°C	8 µMAX
MAX7423CUA	0°C to +70°C	8 µMAX
MAX7423EUA	-40°C to +85°C	8 µMAX
MAX7424CUA	0°C to +70°C	8 µMAX
MAX7424EUA	-40°C to +85°C	8 µMAX
MAX7425CUA	0°C to +70°C	8 µMAX
MAX7425EUA	-40°C to +85°C	8 µMAX

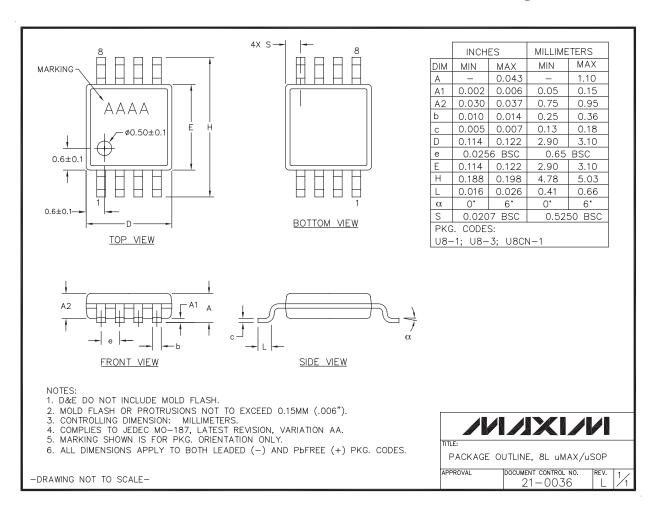
PART	FILTER RESPONSE	OPERATING VOLTAGE (V)
MAX7422	r = 1.6	+3
MAX7423	Bessel	+3
MAX7424	Butterworth	+3
MAX7425	r = 1.25	+3

Chip Information

TRANSISTOR COUNT: 1457

PROCESS: BICMOS

Package Information



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Maxim Integrated:

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        MAX7422EUA+
        MAX7422EUA+T
        MAX7423EUA+
        MAX7424CUA+
        MAX7425CUA+
        MAX7418CUA+

        MAX7418CUA+T
        MAX7418EUA+
        MAX7419CUA+
        MAX7419CUA+
        MAX7419CUA+T
        MAX7419EUA+T

        MAX7420CUA+
        MAX7420CUA+T
        MAX7420CUA+T
        MAX7421CUA+
        MAX7421CUA+T
        MAX7421EUA+T

        MAX7422CUA+
        MAX7422CUA+T
        MAX7423CUA+T
        MAX7423EUA+T
        MAX7424EUA+
        MAX7425EUA+

        MAX7420EUA+
        MAX7421EUA+
        MAX7421EUA+
        MAX7424EUA+
        MAX7425EUA+
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